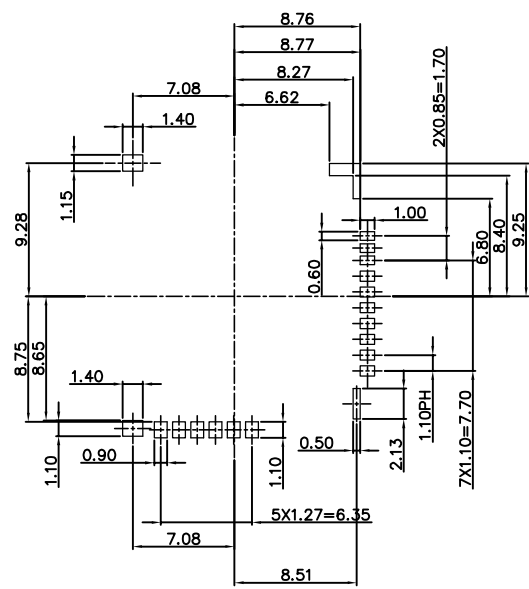



T-FLASH CARD				SIM CARD	
pin No	NAME	TYPE	DESCRIPTION	pin No	NAME
1	DAT2	I/O/PP	Date Line[bit2]	C1	VCC
2	CD/DAT3	I/O/PP	Card Detect Date Line[bit3]	C2	RST
3	CMD	PP	Commend Response	C3	CLK
4	VDD	S	Supply Voltage	C4	GND
5	CLK	I	Clock	C5	VPP
6	VSS	S	Supply Voltage Ground	C6	I/O
7	DAT0	I/O/PP	Date Line[bit0]		
8	PAT1	I/O/PP	Date Line[bit0]		

Notes:

- 1.MATERIAL
  - 1.1 Housing:LCP UL 94V-0 Black.
  - 1.2 Contacts:PHOSPHOR BRONZE(C5210R-EH)
  - 1.3 Shell:SUS304
- 2.Plating:
  - 2.1 Contacts:50u" MIN NICKEL UNDERPLATED, 100u" MIN Sn PLATED SOLDER TAILS.1U" MIN GOLD PLATED CONTACT AREA
  - 2.2 Shell:Gold flash on soldertall area. 50u" MIN NICKEL over ALL
- 3.ELECTRICAL CHARACTERISTICS:
  - 3.1 Operation voltage: 100 V AC max.
  - 3.2 Current rating : 0.5 Amps max.
  - 3.3 Contact resistance: 40m ohms max.
  - 3.4 Insulation resistance: 1000M ohms min. 500 VDC
  - 3.5 Dielectric withstanding voltage: 500 VAC / 1minute
  - 3.6 Operatng Temperature: -25°C to +85°C



RECOMMENDER PCB LAYOUT  
TOLERANCE UNLESS OTHERWISE IS ±0.05



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<b>TOLERANCE:</b> XX ±0.30 XXX ±0.25 XXXX ±0.15 X° ±2°    XX° ±0.5°	<b>DRAWN BY:</b> 陈一鸣	<b>DATE:</b> 2014-02-23	<b>PART NAME:</b> TF+SIM 2合一卡座 全贴片
	<b>CHECKED BY:</b> 马跃	<b>DATE:</b> 2014-02-23	<b>PART NO.:</b> HYCW62-2IN116-270B
<b>UNIT:</b> mm [inch]	<b>APPROVED BY:</b> 邱敏	<b>DATE:</b> 2014-02-23	<b>DRAW NO.:</b> HVC-2103111249
<b>SCALE:</b> 1:1 <b>SIZE:</b> A4			<b>SHEET NO.:</b> 1 OF 1